

1. Part No. Expression:

Z3K300-RF-□□

(a)(b)(c) (d) (e) (f) (g)

(a) Series Code

(b) Dimension Code

(c) Material Code

(d) Impedance Code

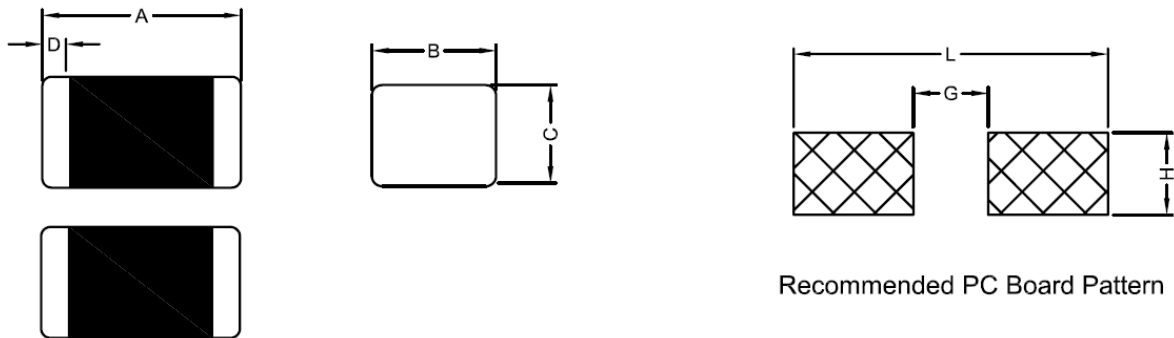
(e) R: Reel

(f) Current Code: F=600mA

(g) 10: Standard

11-99: Internal Controlled Code

2. Configuration & Dimensions:

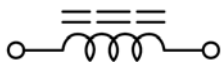


Recommended PC Board Pattern

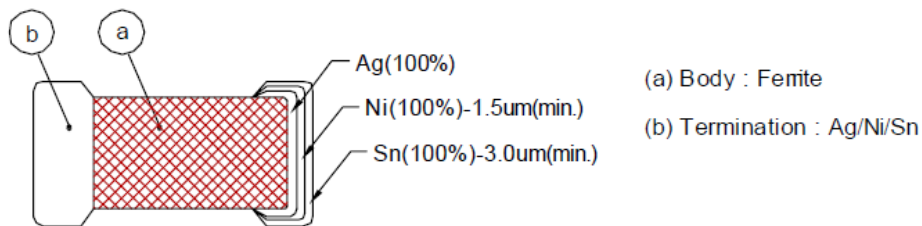
Unit : mm

A	B	C	D	G	H	L
2.0 ± 0.20	1.25 ± 0.20	Refer Table Below	0.50 ± 0.30	1.00 Ref.	1.00 Ref.	3.00 Ref.

3. Schematic:



4. Material List:



NOTE: Specifications subject to change without notice. Please check our website for latest information.

5. General Specification:

- (a) Operating Temp. : -40°C to +125°C
- (b) Storage Temp. : -40°C to +125°C
- (c) Temperature Rise: 20°C Max. at Rated Current
- (d) Humidity Range: 85 ± 2% RH
- (e) Storage Condition (Component in its packaging)
 - i) Temperature: 40°C or less
 - ii) Humidity : 70% RH or less

6. Electrical Characteristics:

Part Number	Dimension C (mm) ± 0.20	Impedance (Ω)	Test Frequency (Hz)	DCR (Ω) Max.	Rated Current (mA) Max.
Z3K110-RI-10	0.85	11 ± 25%	100	0.10	900
Z3K170-RF-10	0.85	17 ± 25%	100	0.10	600
Z3K260-RF-10	0.85	26 ± 25%	100	0.10	600
Z3K300-RF-10	0.85	30 ± 25%	100	0.10	600
Z3K400-RF-10	0.85	40 ± 25%	100	0.10	600
Z3K600-RI-10	0.85	60 ± 25%	100	0.10	900
Z3K121-RH-10	0.85	120 ± 25%	100	0.20	800
Z3K151-RH-10	0.85	150 ± 25%	100	0.20	800
Z3K221-RH-10	0.85	220 ± 25%	100	0.30	750
Z3K301-RG-10	0.85	300 ± 25%	100	0.30	700
Z3K471-RG-10	0.85	470 ± 25%	100	0.35	700
Z3K601-RE-10	0.85	600 ± 25%	100	0.40	500
Z3K102-RD-10	0.85	1000 ± 25%	100	0.45	400
Z3H102-RD-10	0.85	1000 ± 25%	100	0.45	400
Z3H152-RD-10	0.85	1500 ± 25%	100	0.50	350

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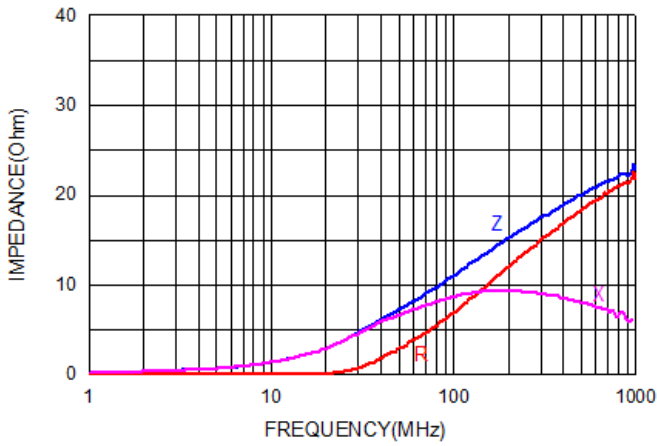
Part Number	Dimension C (mm) ± 0.20	Impedance (Ω)	Test Frequency (Hz)	DCR (Ω) Max.	Rated Current (mA) Max.
Z3H202-RC-10	0.85	2000 ± 25%	100	0.60	250
Z3N070-RF-10	0.85	7 ± 25%	100	0.10	600
Z3C300-RG-10	0.85	30 ± 25%	100	0.20	700
Z3C600-RG-10	0.85	60 ± 25%	100	0.20	700
Z3C121-RG-10	0.85	120 ± 25%	100	0.25	600
Z3C151-RG-10	0.85	150 ± 25%	100	0.25	600
Z3C221-RD-10	0.85	220 ± 25%	100	0.30	400
Z3C301-RD-10	0.85	300 ± 25%	100	0.35	400
Z3C471-RD-10	1.25	470 ± 25%	100	0.40	400
Z3C601-RC-10	1.25	600 ± 25%	100	0.45	300
Z3C102-RB-10	1.25	1000 ± 25%	100	0.50	200

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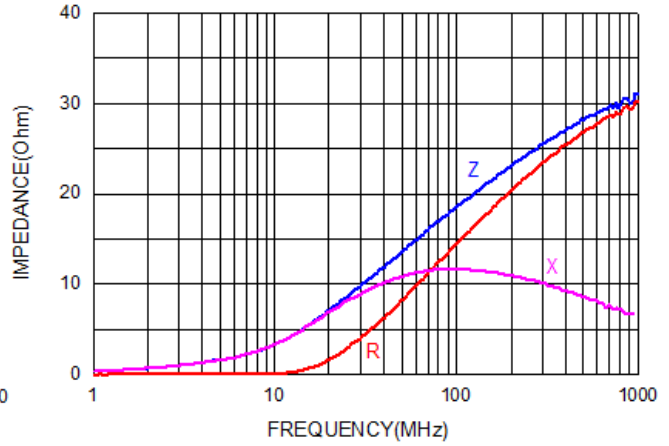


7. Characteristics Curve:

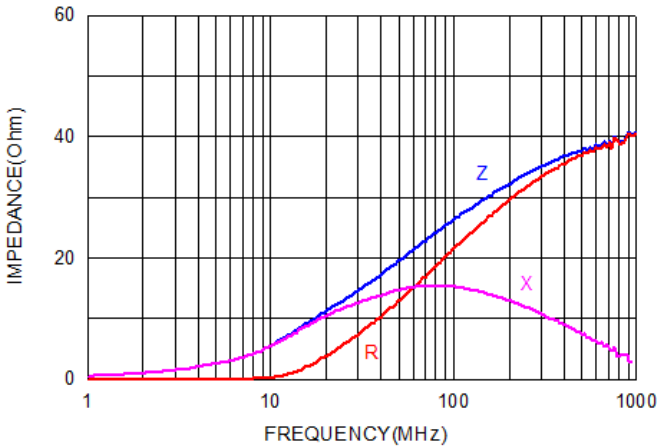
Z3K110-RI-10



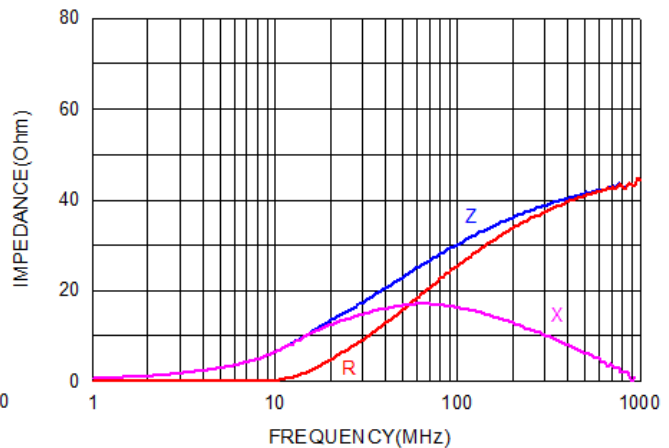
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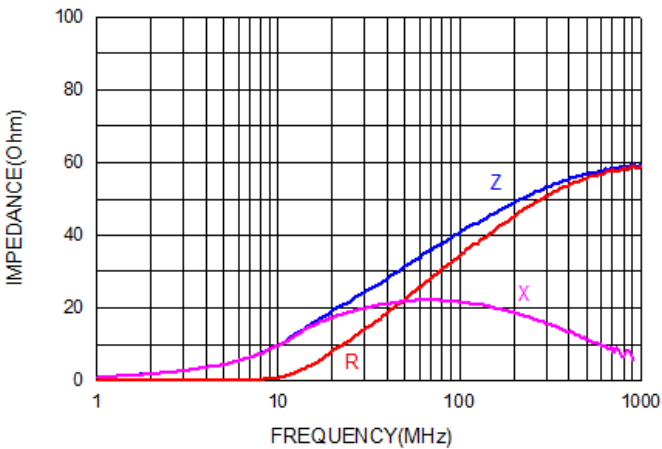
Z3K260-RF-10



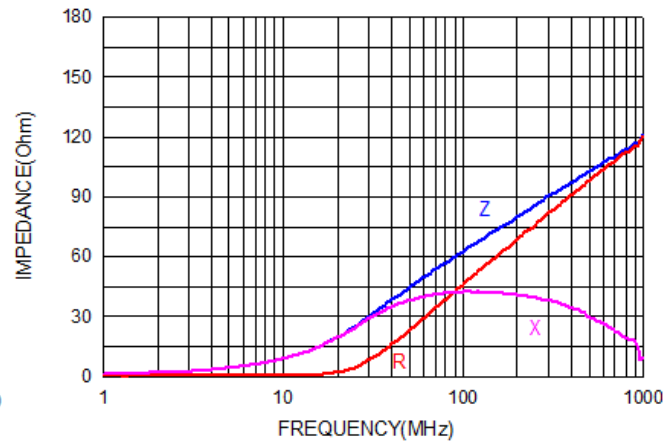
Z3K300-RF-10



Z3K400-RF-10



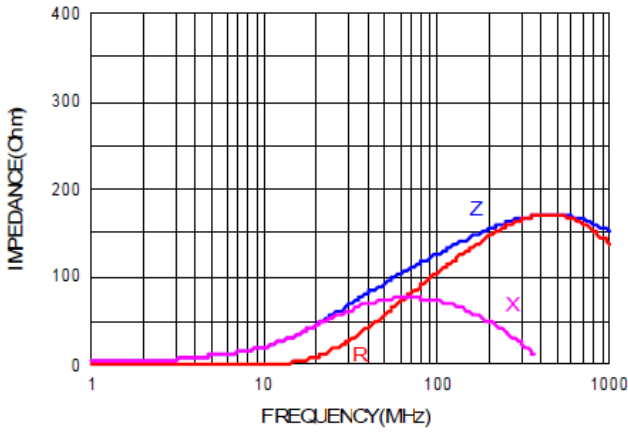
Z3K600-RI-10



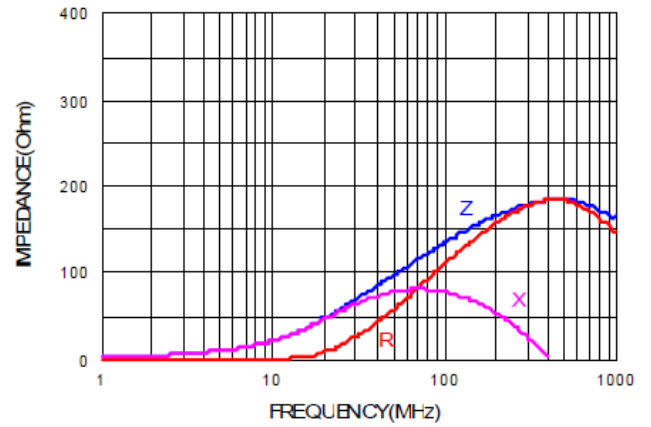
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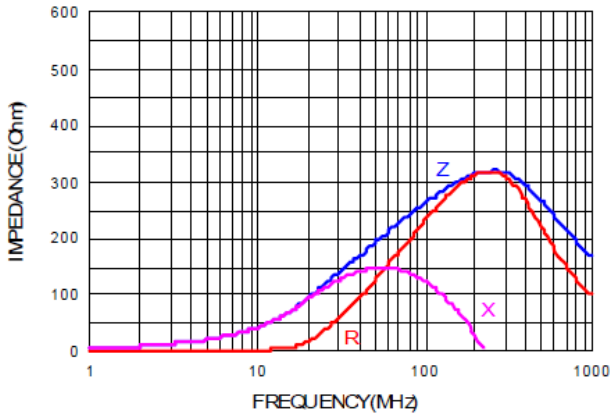
Z3K121-RH-10



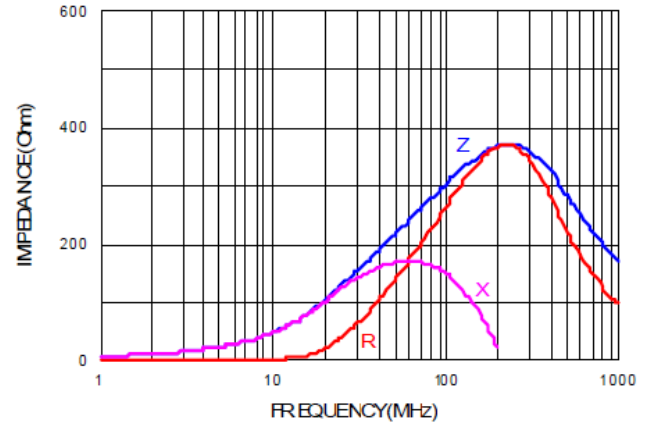
Z3K151-RH-10



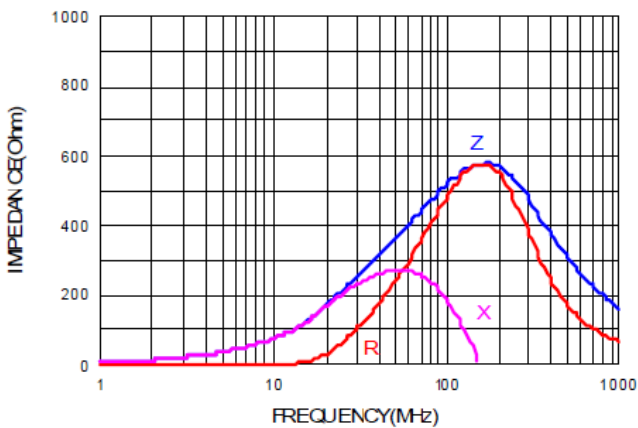
Z3K221-RH-10



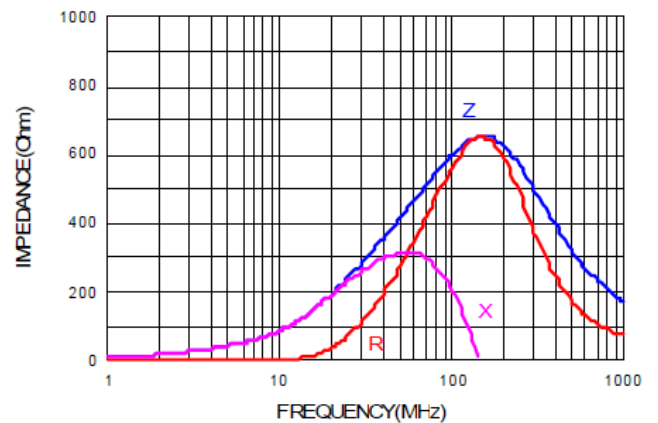
Z3K301-RG-10



Z3K471-RG-10



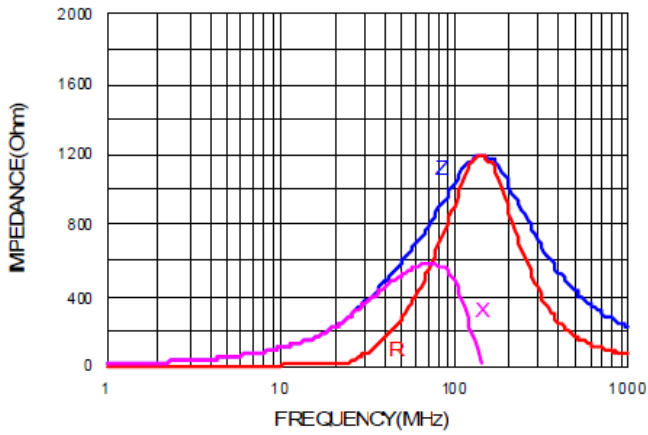
Z3K601-RE-10



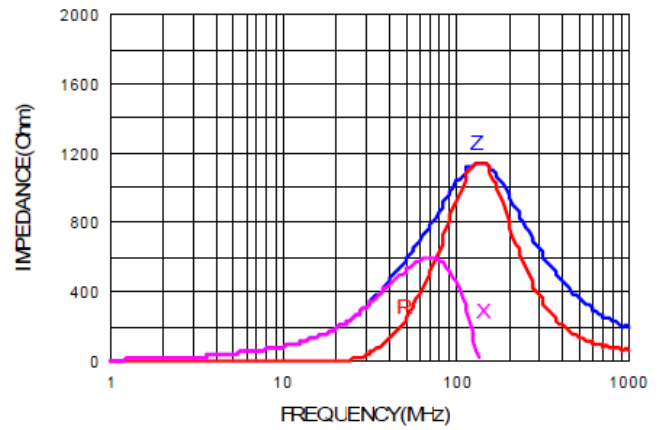
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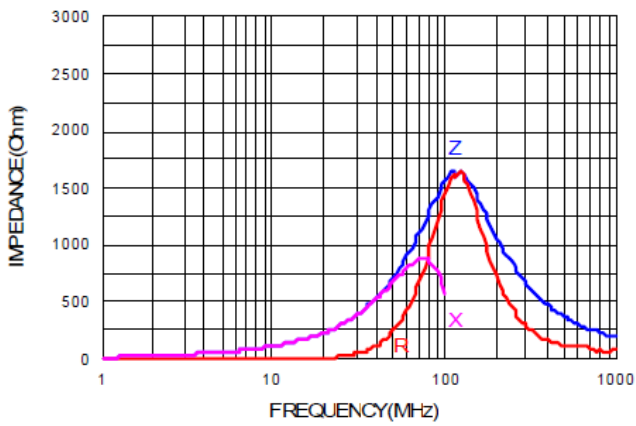
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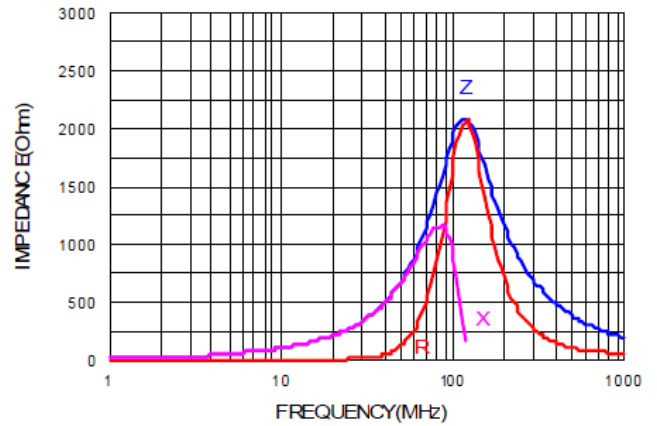
Z3H102-RD-10



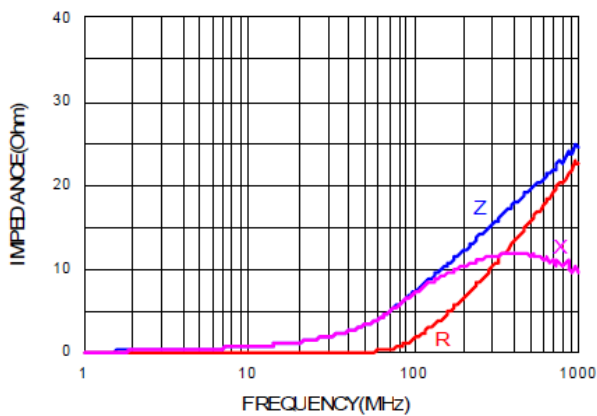
Z3H152-RD-10



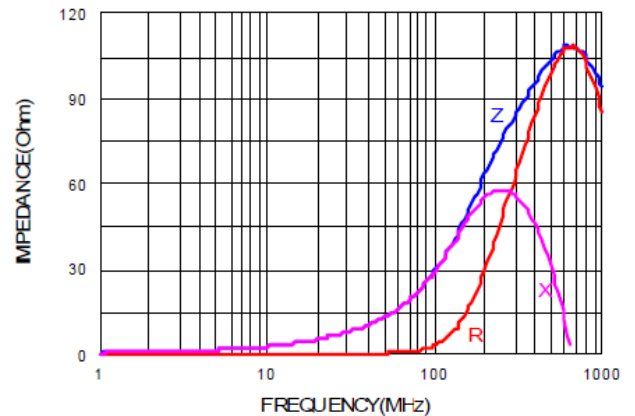
Z3H202-RC-10



Z3N070-RF-10



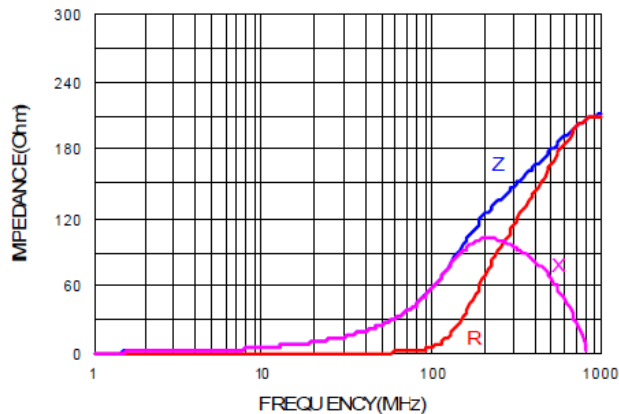
Z3C300-RG-10



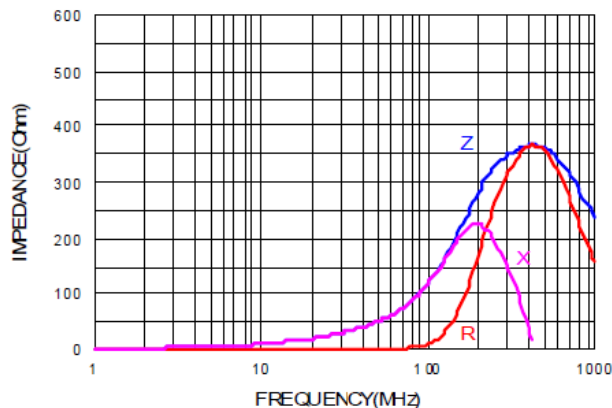
NOTE: Specifications subject to change without notice. Please check our website for latest information.



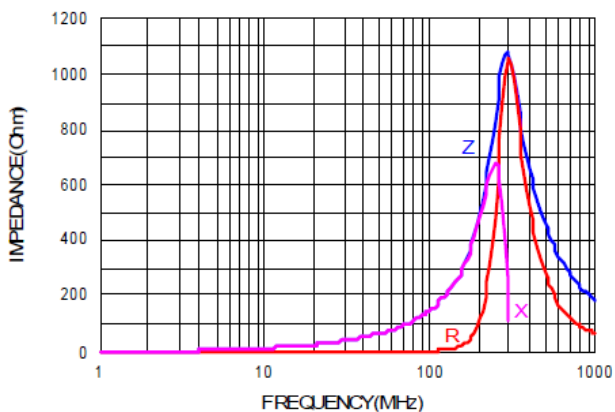
Z3C600-RG-10



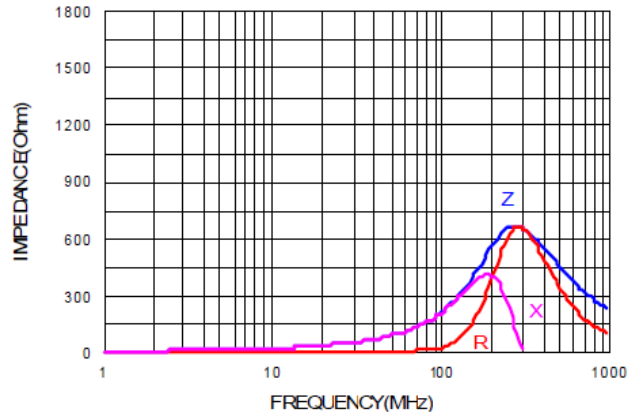
Z3C121-RG-10



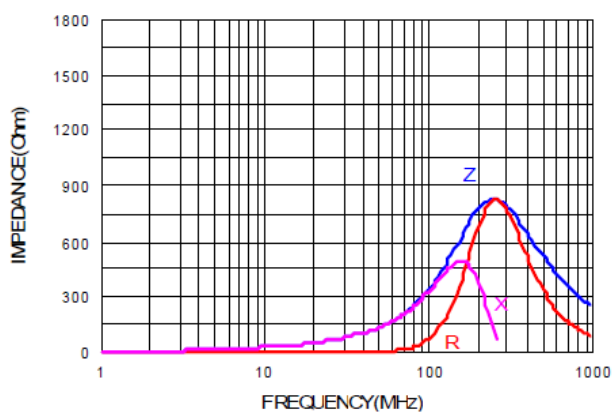
Z3C151-RG-10



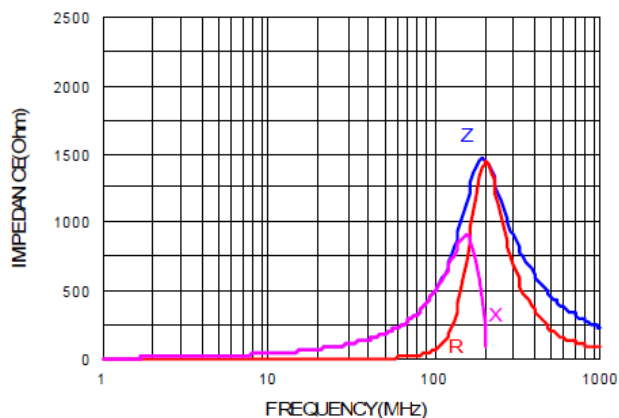
Z3C221-RD-10



Z3C301-RD-10

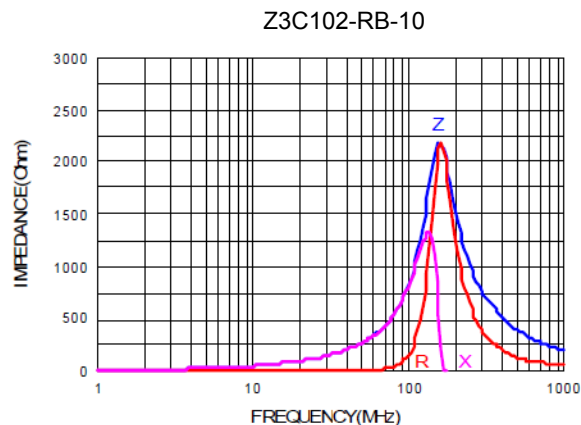
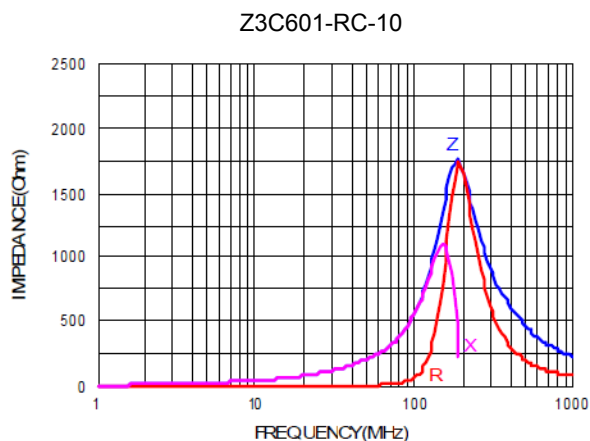


Z3C471-RD-10



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8. Soldering:

Mildly activated rosin fluxes are preferred. Our terminations are suitable for all re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

Note:

If wave soldering is used, there will be some risk

Reflow soldering temperatures below 240°C, there will be non-wetting risk

8-1 Solder Re-flow:

Recommended temperature profiles for re-flow soldering in Figure 1.

8-2 Soldering Iron (Figure 2):

Products attachment with soldering iron is discouraged due to the inherent process control limitations.

In the event that a soldering iron must be employed the following precautions are recommended.

Note :

- a) Preheat circuit and products to 150°C.
- b) 350°C tip temperature (Max.)
- c) Never contact the ceramic with the iron tip
- d) 1.0mm tip diameter (Max.)
- e) Use a 20 watt soldering iron with tip diameter of 1.0mm
- f) Limit soldering time to 4~5 secs.

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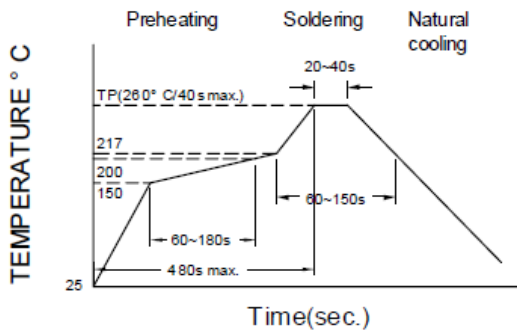


Figure 1. Re-flow Soldering:3 times max

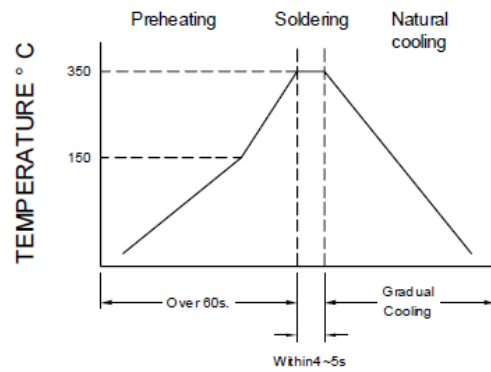


Figure 2. Wave Soldering:1 times max

8-3 Soldering Volume:

By increasing the solder volume, the mechanical stress to product is also increased. Exceeding solder volume may cause the failure of mechanical or electrical performance. Solder shall be used not to be exceeded as shown in Figure 3. Minimum fillet height = soldering thickness +25% product height

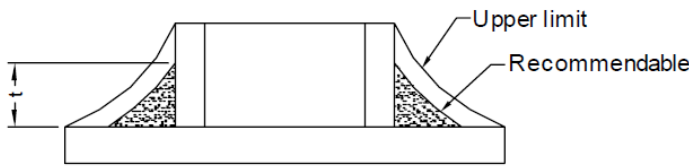
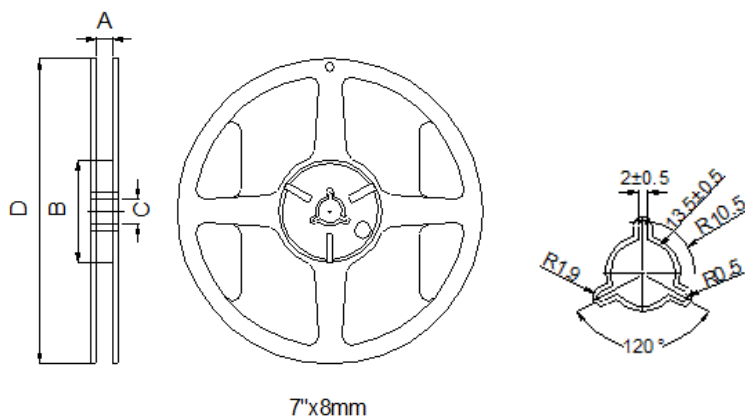


Figure 3

9. Packaging Information:

9-1 Reel Dimension



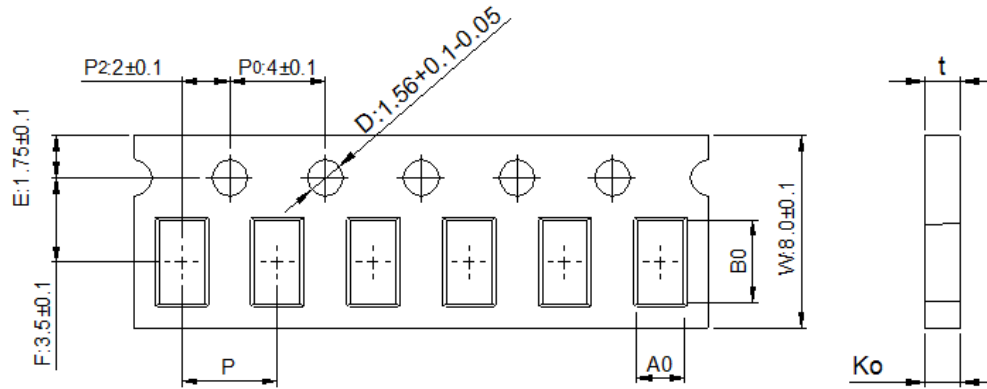
A(mm)	B(mm)	C(mm)	D(mm)
9.0±0.5	60±2	13.5±0.5	178±2

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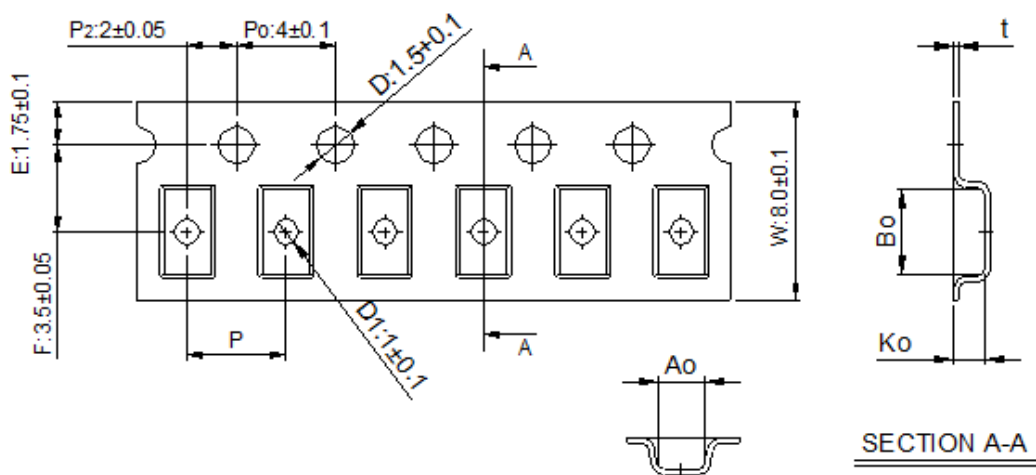
9-2 Tape Dimension

Material of taping is paper



Size	Bo(mm)	Ao(mm)	Ko(mm)	P(mm)	t(mm)
Z3 (09)	2.30±0.05	1.50±0.05	0.95±0.05	4.00±0.10	0.95±0.05

Material of taping is plastic



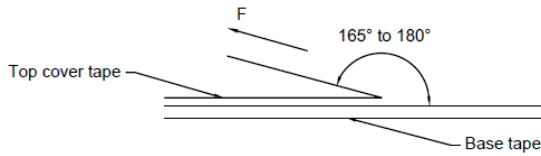
Size	Bo(mm)	Ao(mm)	Ko(mm)	P(mm)	t(mm)	D1 (mm)
Z3 (09)	2.25±0.10	1.42±0.10	1.04±0.10	4.00±0.10	0.22±0.05	1.00±0.10
Z3 (12)	2.35±0.10	1.50±0.10	1.45±0.10	4.00±0.10	0.22±0.05	1.00±0.10

9-3 Packaging Quantity

Chip Size	Z3 (09)	Z3 (12)
Chip/Reel	4000	2000

NOTE: Specifications subject to change without notice. Please check our website for latest information.

9-4 Tearing Off Force



The force for tearing off cover tape is 15 to 60 grams in the arrow direction under the following conditions.

Room Temp. (°C)	Room Humidity (%)	Room atm (hPa)	Tearing Speed mm/min
5~35	45~85	860~1060	300

Application Notice:

1. Storage Conditions:

To maintain the solderability of terminal electrodes:

- a) Recommended products should be used within 12 months from the time of delivery.
- b) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation:

- a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- b) Vacuum pick up is strongly recommended for individual components.
- c) Bulk handling should ensure that abrasion and mechanical shock are minimized

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